

# Bridge Rectifier

## DF005S1-DF10S1

### Description

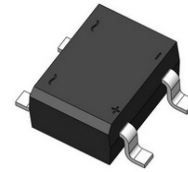
With the ever-pressing need to improve power supply efficiency, improve surge rating, improve reliability, and reduce size, the DFxS1 family sets a new standard in performance and cost saving.

The DFxS1 family balances performance against cost. The design offers a moderate surge rating of 35 A required to handle inrush surge and maintain good reliability, with fair price.

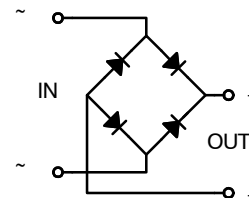
The DFxS1 achieves good performance in a SDIP surface mount form factor, reducing board space and volumetric requirements vs. competitive devices.

### Features

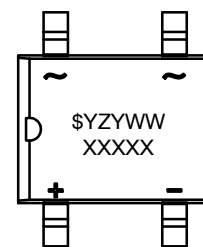
- Maximum Surge Rating:
  - ◆  $I_{FSM} = 35\text{ A}$
  - ◆  $I^2t = 5.1\text{ A}^2\text{Sec}$
- Optimized  $V_F$ : Typical 0.95 V at 1 A, 25 °C
- DF10S Socket Compatible
- Glass Passivated Junctions
- Lead Free Compliant to EU RoHS 2002/95/EU Directives
- Green Molding Compound: IEC61249
- Qualified with IR Reflow and Wave Soldering



PDIP4 GW  
CASE 709AE



### MARKING DIAGRAM



- \$Y = onsemi Logo
- Z = Assembly Plant Code
- YWW = Date Code (Year and Week)
- XXXXX = Specific Device Code

### ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

NOTE: Some of the device on this data sheet have been **DISCONTINUED**. Please refer to the table on page 4.

# DF005S1-DF10S1

**ABSOLUTE MAXIMUM RATINGS** (Values are at  $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted.)

Symbol	Parameter	Value							Unit
		DF005S1	DF01S1	DF02S1	DF04S1	DF06S1	DF08S1	DF10S1	
$V_{RRM}$	Maximum Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000	V
$V_{RMS}$	Maximum RMS Bridge Input Voltage	35	70	140	280	420	560	700	V
$V_{DC}$	Maximum DC Blocking Voltage	50	100	200	400	600	800	1000	V
$I_{F(AV)}$	Maximum Average Forward Current $T_A = 40\text{ }^\circ\text{C}$	1.0							A
$I_{FSM}$	Peak Forward Surge Current 8.3 ms Single Half-Sine Wave Superimposed on Rated Load (JEDEC Method)	35							A
$T_{STG}$	Storage Temperature Range	-55 to +150							$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to +150							$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	Single-Die Measurement (Maximum Land Pattern: $13 \times 13\text{ mm}$ )	65	$^\circ\text{C/W}$
		Multi-Die Measurement (Maximum Land Pattern: $13 \times 13\text{ mm}$ )	50	
		Multi-Die Measurement (Minimum Land Pattern: $1.3 \times 1.5\text{ mm}$ )	105	
$\Psi_{JL}$	Thermal Characterization Parameter, Junction to Lead	Single-Die Measurement (Maximum and Minimum Land Pattern)	27	$^\circ\text{C/W}$

1. The thermal resistances ( $R_{\theta JA}$  &  $\Psi_{JL}$ ) are characterized with the device mounted on the following FR4 printed circuit boards, as shown in Figure 1 and Figure 2. PCB size:  $76.2 \times 114.3\text{ mm}$ . Heating effect from adjacent dice is considered and only two dice are powered at the same time.

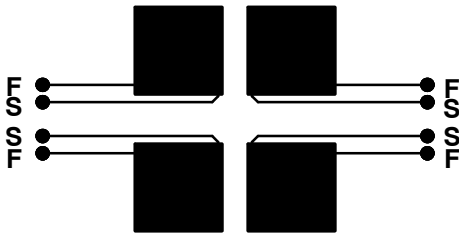


Figure 1. Maximum Pads of 2 oz Copper



Figure 2. Minimum Pads of 2 oz Copper

## ELECTRICAL CHARACTERISTICS (Values are at $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_F$	Forward Voltage Drop per Bridge Element	$I_F = 1.0\text{ A}$			1.1	V
$I_R$	DC Reverse Current at Rated DC Blocking Voltage	$T_J = 25\text{ }^\circ\text{C}$			3	$\mu\text{A}$
		$T_J = 125\text{ }^\circ\text{C}$			500	
$I^2t$	Rating for Fusing ( $t < 8.3\text{ ms}$ )				5.1	$\text{A}^2\text{S}$
$C_J$	Junction Capacitance	$V_R = 4.0\text{ V}$ , $f = 1.0\text{ MHz}$		10		pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

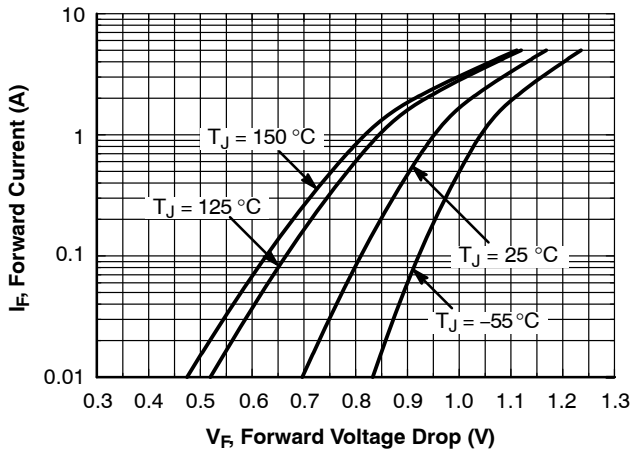


Figure 3. Typical Instantaneous Forward Characteristics

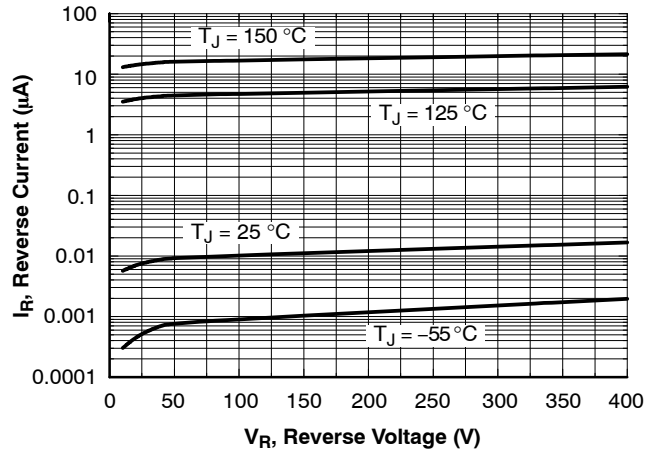


Figure 4. Typical Reverse Characteristics

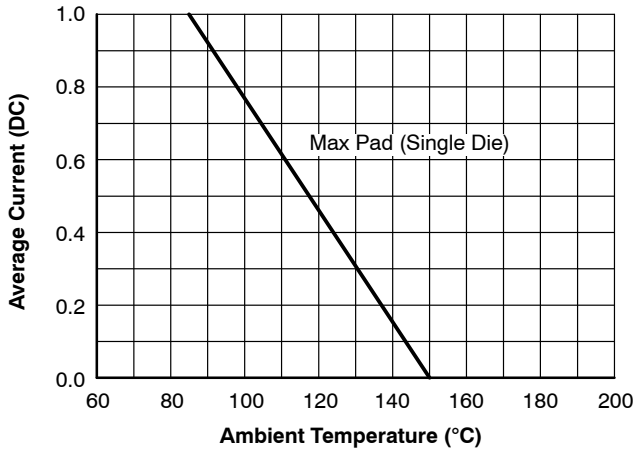


Figure 5. Maximum Average Current vs. Ambient Temperature

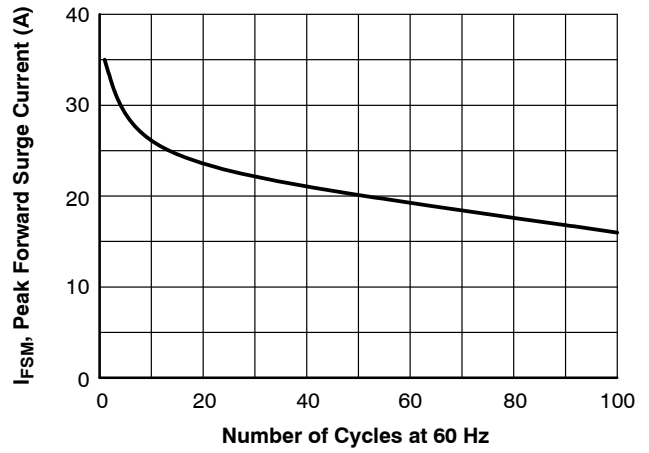


Figure 6. Peak Forward Surge Current vs. Number of Cycles at 60 Hz

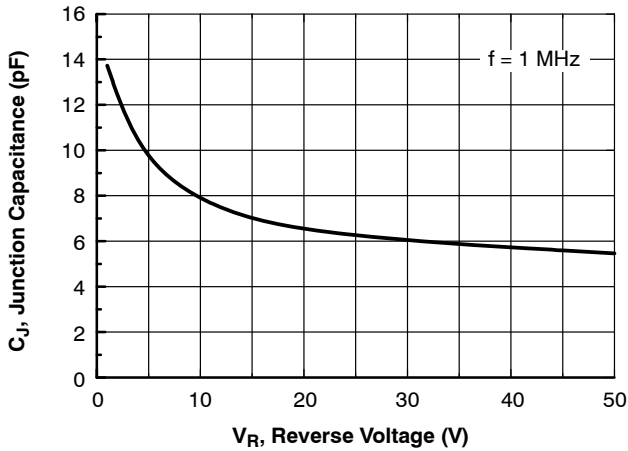


Figure 7. Typical Junction Capacitance

# DF005S1-DF10S1

## ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping <sup>†</sup>
DF08S1	DF08S1	PDIP4 GW (Pb-Free, Halide Free)	1500 / Tape & Reel

## DISCONTINUED (Note 2)

Part Number	Top Mark	Package	Shipping <sup>†</sup>
DF005S1	DF005S1	PDIP4 GW (Pb-Free, Halide Free)	1500 / Tape & Reel
DF01S1	DF01S1		
DF02S1	DF02S1		
DF04S1	DF04S1		
DF06S1	DF06S1		
DF10S1	DF10S1		

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

2. **DISCONTINUED:** These devices are not available. Please contact your **onsemi** representative for information. The most current information on these devices may be available on [www.onsemi.com](http://www.onsemi.com).

# DF005S1-DF10S1

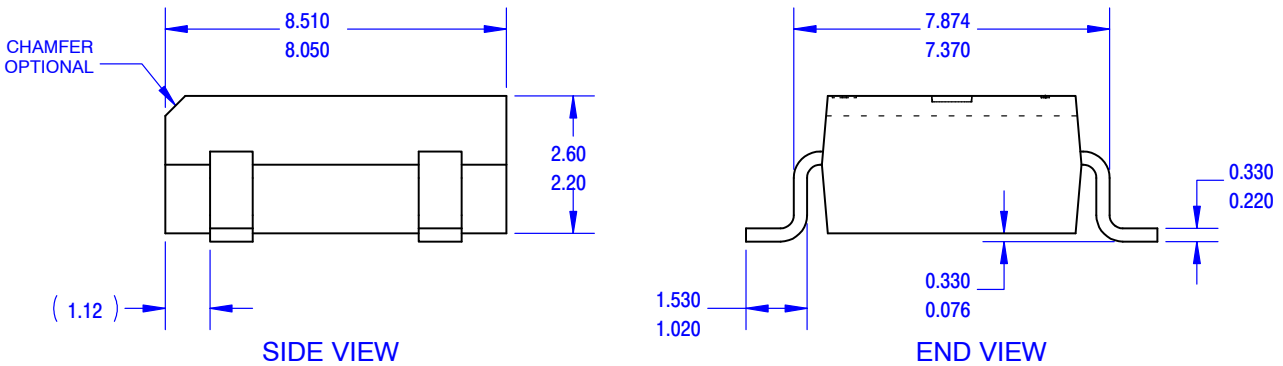
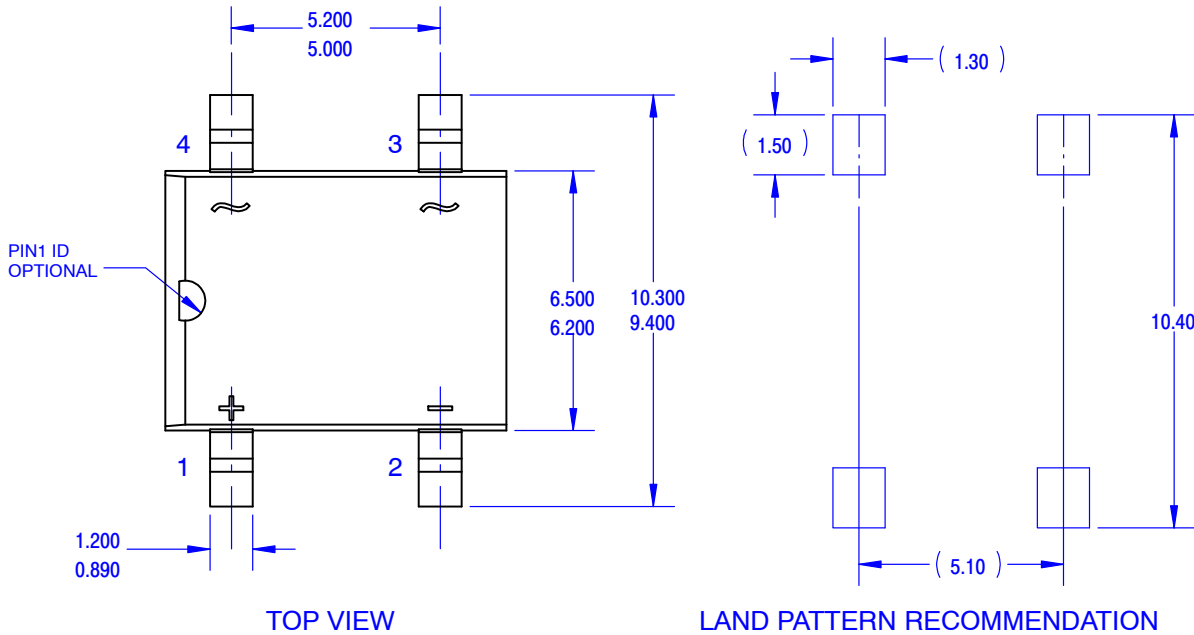
## REVISION HISTORY

Revision	Description of Changes	Date
4	Removed "Discontinued" watermark and updated Ordering Information table according to current part number availability.	4/13/2026

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.

**PDIP4 GW**  
**CASE 709AE**  
**ISSUE O**

DATE 31 JUL 2016



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